

07-02-1998

HEET

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To the Honorable Commissioner of Patents and Trademarks Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

**KUO CHING HUANG, TSE-LIANG YING AND  
CHIA-SHIUNG TSAI**Additional name(s) or conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ other \_\_\_\_\_

Execution Date: 6/5/98

2. Name and address of receiving party(ies):

Name: Taiwan Semiconductor Manufacturing  
Company

Internal Address

Street Address:

**121 Park Ave. 3  
Science-Based Industrial Park  
City: Hsin-Chu Zip:  
Country: Taiwan, R.O.C.**

Additional name(s) & address(es) attached? Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 6/5/98A. Patent Application No(s)B. Patent No(s)Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: GEORGE O. SAILE

Internal Address: \_\_\_\_\_

Street Address: 20 MCINTOSH DRIVECity: POUGHKEEPSIE State: NY ZIP: 126036. Total no. of applications and patents involved: 17. Total fee (37 CFR 3.41) \$ 40.00☐ Enclosed☒ Authorized to be charged to deposit acct.8. Deposit account number: 19-0033

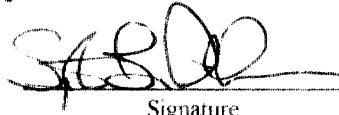
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9. Statement and signature.

*To the best of my knowledge and belief the foregoing information is true and correct and any attached copy is a true copy of the original document*STEPHEN B. ACKERMAN

Name of Person Signing



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6/16/98

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Total number of pages comprising cover sheet: 3

PATENT

REEL: 9273 FRAME: 0563

JCS11 U.S. PTO  
09/099809  
06/18/98

For ☒ U.S. and/or ☒ Foreign Rights

For ☒ Application or ☐ U.S. Patent

By ☒ Inventor(s) or ☐ Present Owner

### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR:

KUO CHING HUANG  
Type or print name of ASSIGNOR

7F, No. 6, Alley 9, Lane 546, Hsu-Chang  
Address

Rd., Nan-Tzu, Kaohsiung, Taiwan.

Republic of China  
Nationality

TSE LIANG YING  
Type or print name of ASSIGNOR

8F-3 No. 912, Sec. 2, Kung-Fu  
Address

Rd, Hsin-Chu, Taiwan

Republic of China  
Nationality

CHIA SHILING TSAI  
Type or print name of ASSIGNOR

3F, 107 Sun Hsien Tower Shuang Hsi  
Address

Village Po-Shan County Hsin-Chu Taiwan

Republic of China  
Nationality

#### ASSIGNEE:

**Taiwan Semiconductor Manufacturing Co. Ltd.**

**121 Park Ave. 3**

**Science-Based Industrial Park**

**Hsin-Chu, Taiwan, R.O.C.**

**Taiwan, R.O.C.**

Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

☒ the entire right, title and interest

☐ an undivided \_\_\_\_\_ percent (\_\_\_\_%) interest for the United States and its territorial possessions  
(check the following box if foreign rights are also to be assigned)

☒ and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

A New Method To Form Trench-Free Buried Contact  
In Process With STI Technology

PATENT

REEL: 9273 FRAME: 0564

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith  
(b) ☐ U.S. patent application executed on \_\_\_\_\_  
(c) ☐ U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_  
(d) ☐ U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
(e) ☐ and any legal equivalent thereof in a foreign country, including the right to claim priority  
(also check (e) if foreign application(s) is also being assigned)

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof

IN WITNESS WHEREOF, I / We have signed this

June 5, 1998 (Date of signing)

**WARNING** Date of signing must be the same as the date of execution of the application if item (a) was checked above

Kuo Chie Huang  
Signature of ASSIGNOR(S)  
Lu-Liang Jing  
Wen Sheng Bai

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

\_\_\_\_\_  
Notarization or Legalization Page Added.